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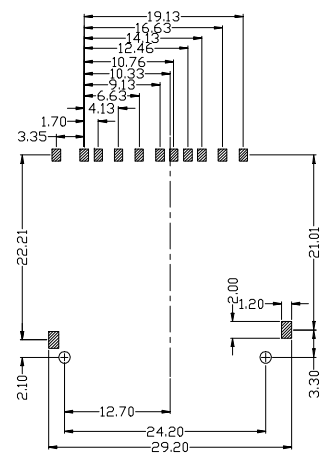
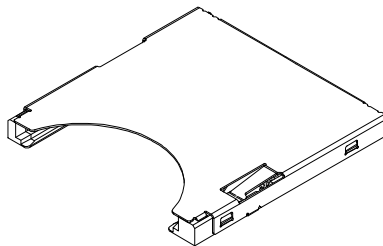
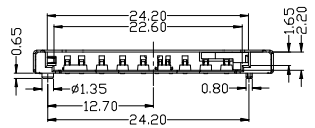
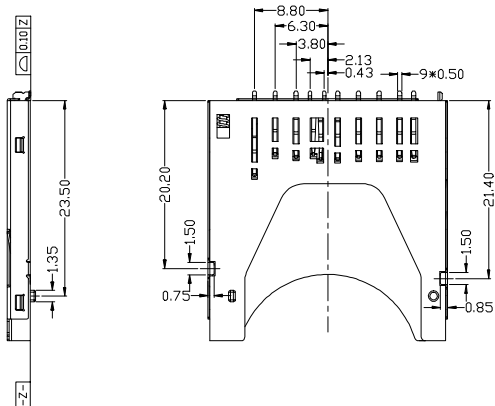
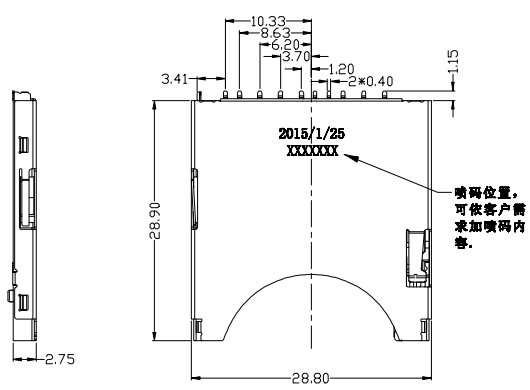
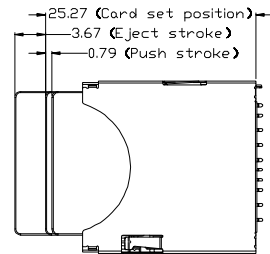
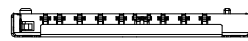
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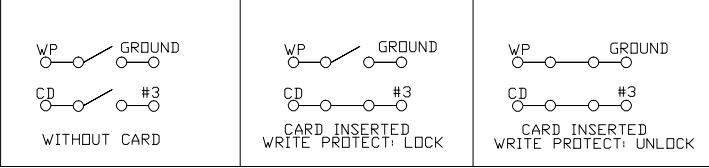
8 7 6 5 4 3 2 1



RECOMMENDED P.C.B HOLE LAYOUT COMPONENT SIDE VIEW(TOLERANCE: +/-0.05)

- 1.MATERIAL:
 1.1 INSULATOR: LCP, UL94V-0; COLOR: BLACK.
 1.2 CONTACT: C5191R-EH T=0.15mm
 1.3 GRDUND: C5191R-EH T=0.15mm
 1.4 SHELL: STAINLESS STEEL. T=0.20mm
- 2.FINISH:
 2.1 CONTACT: GOLD FLASH PLATED IN CONTACT AREA ; 100U* MIN. TIN PLATED IN SOLDER AREA 50U* MIN. NICKEL UNDERPLATED OVERALL.
 2.2 SHELL: 50U* MIN. NICKEL PLATED OVERALL, AND GOLD FLASH PLATED IN SOLDER AREA
- 3.ELECTRICAL CHARACTERISTICS
 3.1 CURRENT RATING: AC/DC 0.5A.
 3.2 CONTACT RESISTANCE: 100mΩ MAX.
 3.3 INSULATION RESISTANCE: 1000MΩ MIN DC 250V.
 3.4 DIELECTRIC WITHSTANDING VOLTAGE: AC 500V PER MINUTE.
 3.5 OPERATING TEMPERATURE: -20°C ~ +65°C.
 3.6 MATING CYCLE:10000CYCLES,SPRING IS NOT BREAKING.
- 4.NOTES:
 4.1 THIS COMPONENT AND ITS HOMOGENEOUS SUBCOMPONENTS ARE ROHS2.0 COMPLIANT.
 4.2 RESISTANCE TO SOLDERING HEAT: 260±5°C FOR 10 SECONDS.
 4.3 COPLANARITY IS 0.1MM MAX

CIRCUIT



深圳市连欣科技有限公司

TOLERANCE: X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 X: ±2' X.X' ±0.5'	DRAWN BY : 马明	DATE : 2016-02-23	PART NAME: SD PUSH 定位片向内	
	CHECKED BY: 叶永清	DATE : 2016-02-23	PART NO.:	XFSD-0526-0823B
 UNIT: mm [inch] SCALE:1:1 SIZE: A4	APPROVED BY: 陈国鸣	DATE : 2016-02-23	MOLD NO.:	
			DRAW NO.:	SD17112815
			SHEET NO.:	1 OF 1